

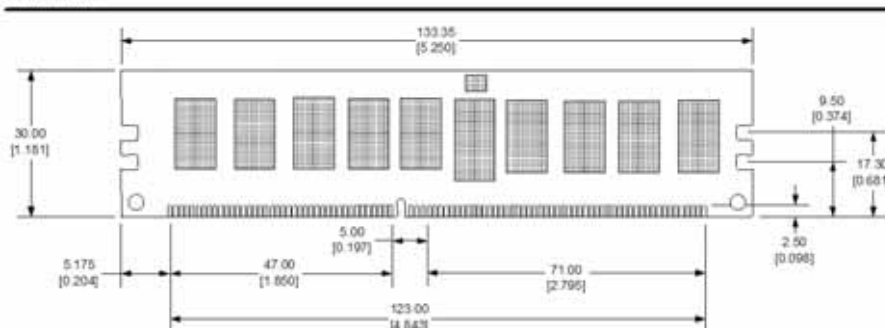
Products in Family

GRSX2270Q/16GB (1 x 16GB 2Rx4 DIMMs)



Features		Description
240-pin JEDEC-compliant DIMMs 133.35 mm wide by 30 mm high (1.181" x 5.25") Data Transfer Rate: 10.6 Gigabytes/sec Operating Voltage: 1.5 V \pm 0.075 Fully RoHS Compliant Thermal Sensor		Each GRSX2270 upgrade consists of a single DDR3-1066 Registered ECC DIMM that conforms to JEDEC's DDR3, PC3-8500 standard. One 2K-bit EEPROM is used for Serial Presence Detect and a combination register/PLL with Address and Command Parity is also used. A thermal sensor accurately monitors the DIMM module and can prevent exceeding the maximum operating temperature of 95C.
Dataram Product	Sun Microsystems Product	Supported in these Sun Microsystems systems:
GRSX2270Q/16GB	Not Offered by Sun	Sun Fire X2270 M2

Front view

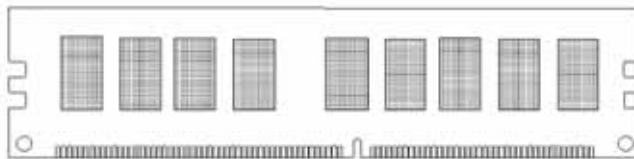


Notes

Tolerances on all dimensions except where otherwise indicated are \pm .13 (.005).

All dimensions are expressed in millimeters [inches]

Back view



Side view

